

# **RX Series**

**RX Picosecond Lasers** 

# TEM<sub>oo</sub>, Picosecond Lasers

With over 15 years of expertise in developing and refining picosecond laser features, performance, reliabilities, after delivering thousands of these RX series lasers, RX Series picosecond lasers deliver exceptional performance, precision, and durability, making them ideal for advanced industrial and scientific applications. our RX series excels in precision manufacturing, scientific research, and ultrafast laser processing. While maintaining consistent reliability and accuracy.

Photonics Industries has earned a reputation as a global leader in ultrafast laser technology. Each laser is built to rigorous quality standards, reflecting our commitment to innovation and customer satisfaction. Our proven track record demonstrates our ability to address complex challenges and deliver solutions that empower cutting-edge industries and research.



### **APPLICATIONS**

- Marking & Scribing
- Medical Device Laser Micro processing
- Thin Film Removal and Processing
- PCB & Polymer Cutting & Drilling
- Selective Annealing and Doping
- Solar Cell Manufacturing
- Semiconductor Processing
- Micromachining Transparent Materials

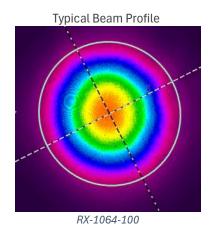
### **FEATURES**

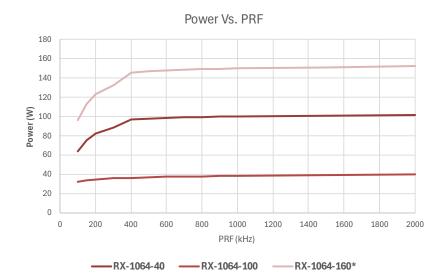
- Up to ~900µJ Pulse Energy at 100kHz
- True TEM<sub>00</sub> Output, M<sup>2</sup><1.3</li>
- Exceptional point stability (<25urad)</li>
- Ultra-Short Pulse Widths (10ps @1064nm) (~7ps@ 532/355nm)
- Burst Mode for Pulse Control
- Robust & Compact Form Factor
- Dynamic Pulse Energy Control PEC
- Position Synchronized Output PSO
- Power Monitoring and Self-Calibration



	RX-1064-40	RX-1064-100	RX-1064-150
Wavelength		1064nm	
Average Power @ 1MHz	40W	100W	150W
Pulse Energy @100kHz	~300µJ	~600µJ	~900µJ
Pulse Width		~10ps	
Pulse repetition rate		Single shot to 2MHz	
Pulse-to-pulse stability		<1% rms	
Long-term power stability <sup>1</sup>		≤1% rms	
Beam spatial mode & M <sup>2 †</sup>	TEM <sub>00</sub> - M <sup>2</sup> < 1.3	TEM <sub>00</sub> -	M <sup>2</sup> < 1.2
Beam divergence (nominal)		<1.5 mrad	
Beam bore sight accuracy	≤ 1 mm lateral (to specified	exit location), ≤ 5 mrad angular	(to specified exit direction)
Beam roundness	>90%		
Beam pointing stability	<25 µrad		
Polarization ratio		Vertical; >100:1	
	Operatio	nal Specifications and Charac	teristics
Interface	RS232, Ethe	ernet, Software GUI, External TTI	_ Triggering
Warm-up time	< 5 minutes from standby, <15 minutes from cold start		
Electrical requirement	32 V DC, 15 A 32 V DC, 28 A 60/32 V DC		60/32 V DC, 20/18 A
Line frequency		50-60 Hz	
Power consumption	<500W	<900W	<1300W
Dimensions	16 x 8.5 x 4.5 in.	20 x 8.5 x 4.5 in.	20 x 10 x 4.5 in.
Weight	~38lbs	~47lbs	~57lbs
	Environmental Requirements		
Ambient temperature <sup>2</sup>	Ambient 15	°C to 30°C (59°F to 86°F) Opera	ting Range
Ambient temperature	Relative h	umidity 0% to 80% max, non-co	ndensing
Storage conditions	-1	0°C to 40°C; sea level to 12000	m
Storage containons	0% to 8	0% relative Humidity, non-cond	ensing
Cooling system	Water-Cooled		

<sup>[1]</sup> Measured over 8 hours ± 2°C. [2] For operation of the laser outside of the specified temperature range, contact PI. [†] ALL beam parameters and stability are at specification 1MHz repetition rate \*Illustration includes some simulated data for conceptual visualization.

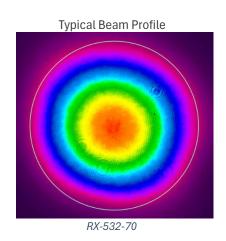


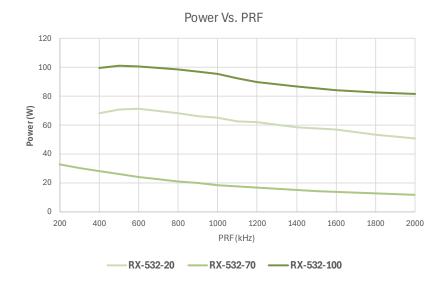




Specifications – <b>RX Series</b>				
	RX-532-20 RX-532-70 RX-532-100		RX-532-100	
Wavelength		532nm		
Average Power @ 1MHz <sup>1</sup>	25W	70W	100W	
Pulse Energy @100kHz²	~180µJ	~400µJ	~600µJ	
Pulse Width		~7ps		
Pulse repetition rate		Single shot to 2MHz		
Pulse-to-pulse stability		<2% rms		
Long-term power stability <sup>3</sup>		≤1% rms		
Beam spatial mode & M <sup>2 †</sup>		TEM <sub>00</sub> - M <sup>2</sup> <1.2		
Beam divergence (nominal)		< 1 mrad		
Beam bore sight accuracy	≤ 1 mm lateral (to specified exit location), ≤ 5 mrad angular (to specified exit direction)			
Beam roundness		>90%		
Beam pointing stability	<25 μrad			
Polarization ratio		Horizontal; >100:1		
	Operation	onal Specifications and Charac	teristics	
Interface	RS232, Ethernet, Software GUI, External TTL Triggering		_ Triggering	
Warm-up time	< 5 minutes from standby, <15 minutes from cold start		n cold start	
Electrical requirement	32 V DC, 15 A 32 V DC, 28 A 60/32 V DC,		60/32 V DC, 20/18 A	
Line frequency		50-60 Hz		
Power consumption	<500W	<900W	<1300W	
Dimensions	16 x 8.5 x 4.5 in.	20 x 8.5 x 4.5 in.	20 x 10 x 4.5 in.	
Weight	~38lbs	~47lbs	~57lbs	
		<b>Environmental Requirements</b>		
Ambient temperature 4	Ambient 15	s°C to 30°C (59°F to 86°F) Opera	ting Range	
Ambient temperature	Relative h	umidity 0% to 80% max, non-co	ndensing	
Storage conditions	-1	0°C to 40°C; sea level to 12000	m	
otorage continuitions	0% to 8	30% relative Humidity, non-cond	ensing	
Cooling system		Water-Cooled		

[1] Specification is based on 1MHz optimized performance data. [2] Specifications for power and pulse energy are provided for specific repetition rates and are not achievable simultaneously. The listed power and pulse energy apply exclusively to their respective repetition rates. Please inform Photonics Industries of your desired operational PRF (kHz) when placing your order. [3] Measured over 8 hours ± 2°C. [4] For operation of the laser outside of the specified temperature range, contact PI. [†] ALL beam parameters and stability are at specification 1MHz repetition rate \*Illustration includes some simulated data for conceptual visualization.

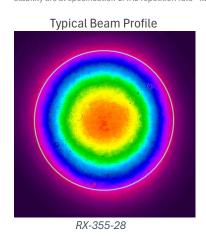


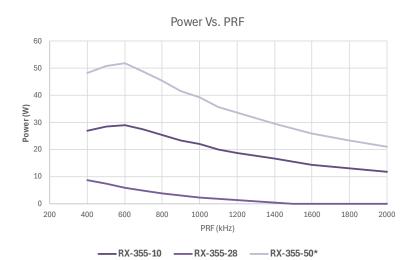




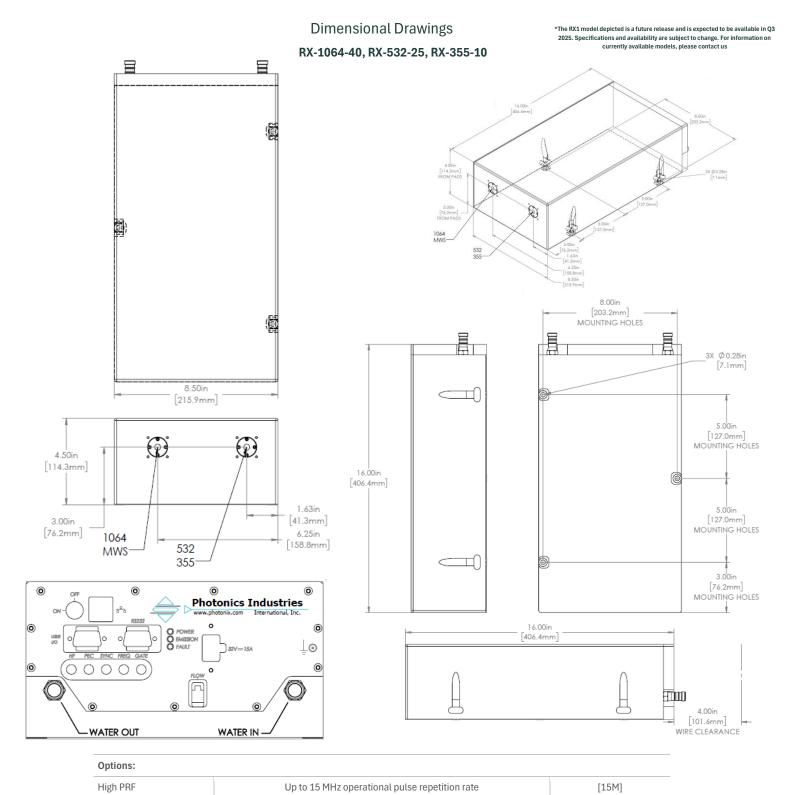
Specifications – <b>RX Series</b>				
	RX-355-10	RX-355-28	RX-355-50	
Wavelength		355nm		
Average Power @ 1MHz <sup>1</sup>	10W	28W	50W	
Pulse Energy @100kHz²	~80µJ	~200µJ	~280µJ	
Pulse Width		~7ps		
Pulse repetition rate		Single shot to 2MHz		
Pulse-to-pulse stability		<2% rms		
Long-term power stability <sup>3</sup>		≤1% rms		
Beam spatial mode & M <sup>2 †</sup>		$TEM_{00} - M^2 < 1.2$		
Beam divergence (nominal)		<1 mrad		
Beam bore sight accuracy	≤ 1 mm lateral (to specified	ified exit location), ≤ 5 mrad angular (to specified exit direction)		
Beam roundness		>90%		
Beam pointing stability		<25 µrad		
Polarization ratio	Vertical; >100:1	ertical; >100:1 Horizontal; >100:1		
	Operation	Operational Specifications and Characteristics		
Interface	RS232, Eth	ernet, Software GUI, External TTL Triggering		
Warm-up time	< 5 minutes	from standby, <15 minutes from cold start		
Electrical requirement	32 V DC, 15 A	32 V DC, 28 A 60/32 V DC, 20/1		
Line frequency		50-60 Hz		
Power consumption	<500W	<900W	<1300W	
Dimensions	16 x 8.5 x 4.5 in.	25.5 x 10 x 4.5in		
Weight	~38lbs	~71	lbs	
		Environmental Requirements		
Ambient temperature 4	Ambient 15	5°C to 30°C (59°F to 86°F) Opera	ting Range	
Ambient temperature	Relative h	umidity 0% to 80% max, non-co	ndensing	
Storage conditions	-1	0°C to 40°C; sea level to 12000 i	n	
Storage conditions	0% to 8	30% relative Humidity, non-cond	ensing	
Cooling system		Water-Cooled		

[1] Specification is based on 1MHz optimized performance data. [2] Specifications for power and pulse energy are provided for specific repetition rates and are not achievable simultaneously. The listed power and pulse energy apply exclusively to their respective repetition rates. Please inform Photonics Industries of your desired operational PRF (kHz) when placing your order. [3] Measured over 8 hours ± 2°C. [4] For operation of the laser outside of the specified temperature range, contact PI. [†] ALL beam parameters and stability are at specification 1MHz repetition rate \*Illustration includes some simulated data for conceptual visualization.



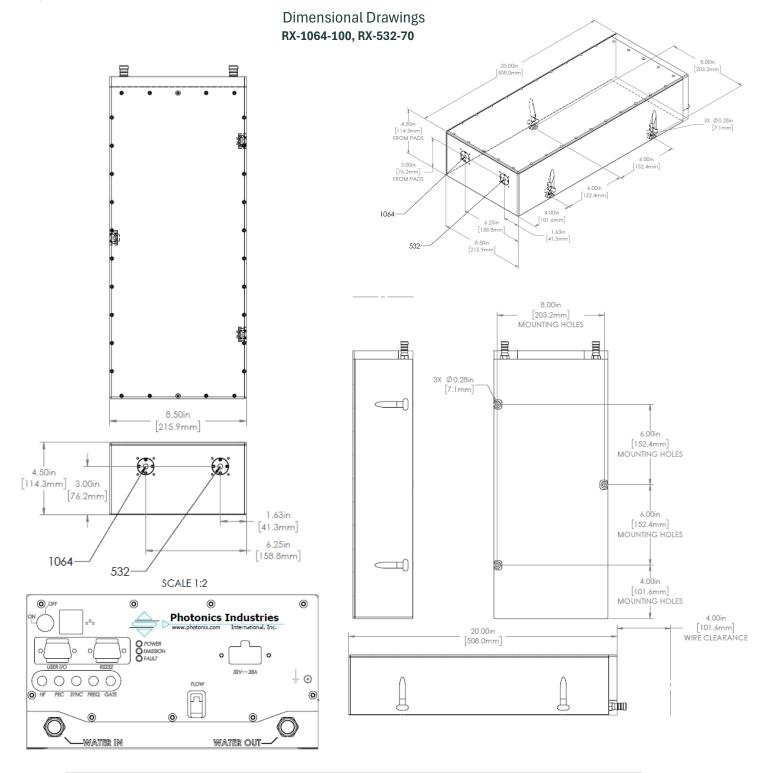






Quasi-CW	~32 MHz fixed pulse repe	etition rate	[QCW]
Multi-wavelength	Multi-wavelength output, blend	ded or selectable	[MWB], [MWS]
Deep Ultraviolet (DUV)	266nm Wavelength available	e upon request	



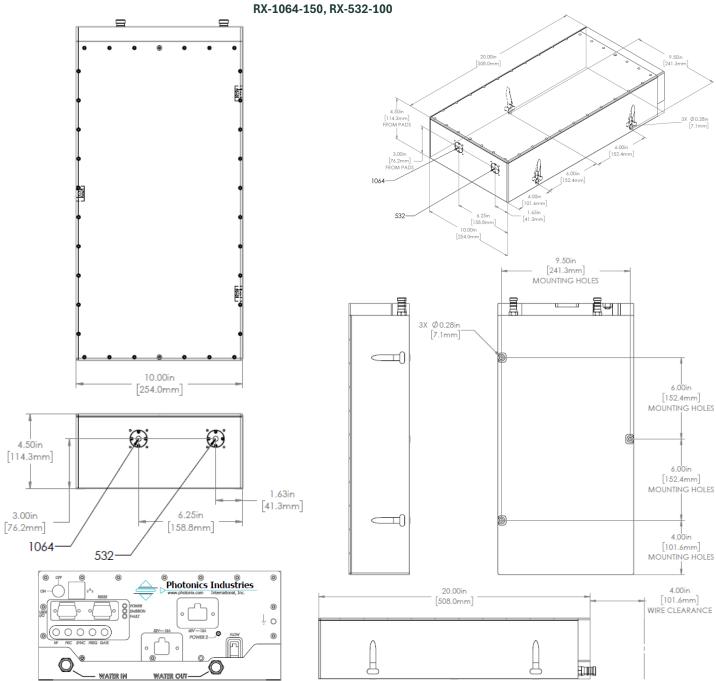


Options:			
High PRF	Up to 15 MHz operational pulse repetition rate	[15M]	
Quasi-CW	~32 MHz fixed pulse repetition rate	[QCW]	
Multi-wavelength	Multi-wavelength output	[MWB]	

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Format	RX-1064/532	-	[Power Level]	-	[XXX]



# Dimensional Drawings

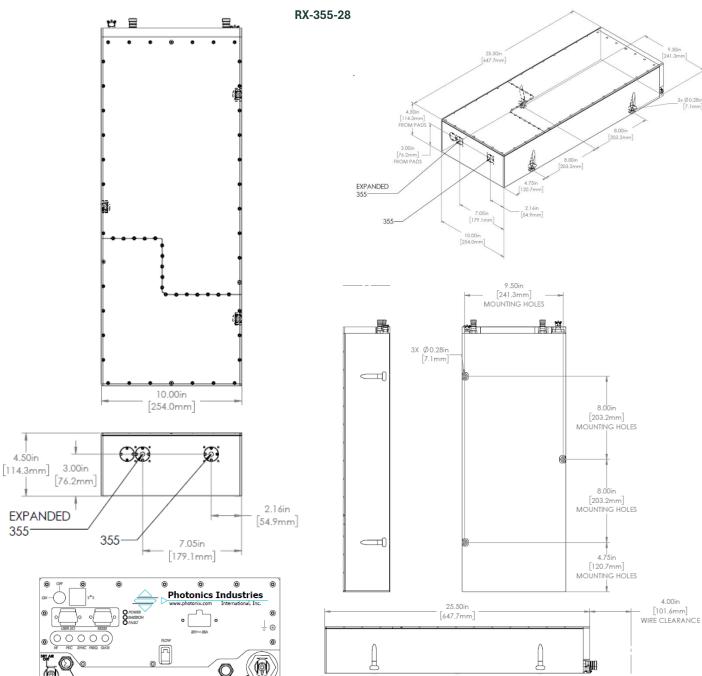


Options:		
High PRF	Up to 15 MHz operational pulse repetition rate	[15M]
Quasi-CW	~32 MHz fixed pulse repetition rate	[QCW]
Multi-wavelength	Multi-wavelength output, blended	[MWB]

Format RX-1064/532 - [Power Level] - [xxx]	Format	RX-1064/532	-	[Power Level]	-	
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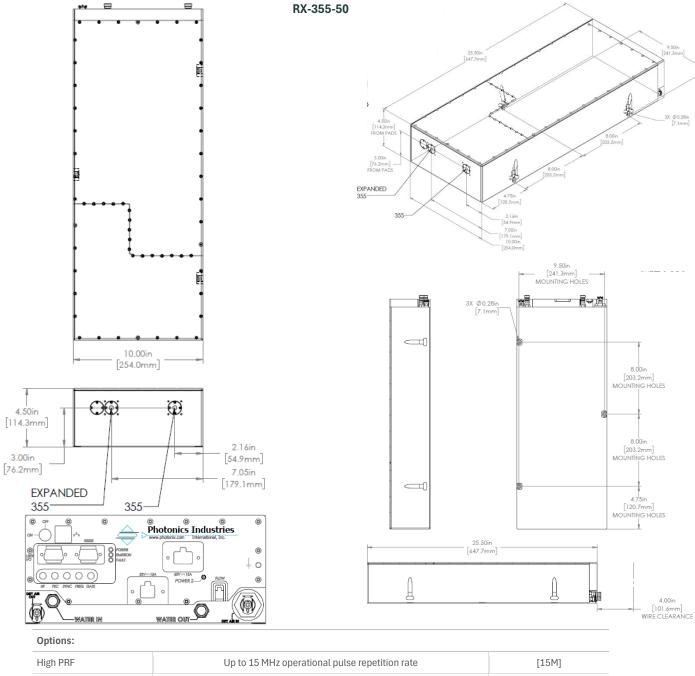
# Dimensional Drawings



Options:			
High PRF	Up to 15 MHz operatio	nal pulse repetition rate	[15M]
Quasi-CW	~32 MHz fixed pu	ılse repetition rate	[QCW
Deep Ultraviolet (DUV)	266nm Wavelength available up	on request *Dimensions may var	/



# **Dimensional Drawings**



High PRF	Up to 15 MHz operational pulse repetition rate	[15M]
Quasi-CW	~32 MHz fixed pulse repetition rate	[QCW]
Deep Ultraviolet (DUV)	266nm Wavelength available upon request *Dimensions may vary	

Format RX-355 - [Power Level] - [xxx]
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Our ongoing policy is to improve the design and specification of our products. The information provided is non-binding.

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Photonics Industries International Inc. is the pioneer of intracavity harmonic lasers and is at the forefront of developing, manufacturing, and marketing a wide range of nanosecond, sub-nanosecond, picosecond, and femtosecond lasers for the industrial, scientific, defense and medical industries.



# 光と人をつなぐ

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